

SKiiP 21 NEB 06 - SKiiP 21 NEB 06 I

Absolute Maximum Ratings		Values	Units
Symbol	Conditions ¹⁾		
Inverter & Chopper			
V_{CES}		600	V
V_{GES}		± 20	V
I_C	$T_{heatsink} = 25 / 80 \text{ }^\circ\text{C}$	20 / 14	A
I_{CM}	$t_p < 1 \text{ ms}; T_{heatsink} = 25 / 80 \text{ }^\circ\text{C}$	40 / 28	A
$I_F = -I_C$	$T_{heatsink} = 25 / 80 \text{ }^\circ\text{C}$	25 / 15	A
$I_{FM} = -I_{CM}$	$t_p < 1 \text{ ms}; T_{heatsink} = 25 / 80 \text{ }^\circ\text{C}$	50 / 30	A
Bridge Rectifier			
V_{RRM}		800	V
I_D	$T_{heatsink} = 80 \text{ }^\circ\text{C}$	25	A
I_{FSM}	$t_p = 10 \text{ ms}; \sin. 180 \text{ }^\circ; T_j = 25 \text{ }^\circ\text{C}$	370	A
I^2t	$t_p = 10 \text{ ms}; \sin. 180 \text{ }^\circ; T_j = 25 \text{ }^\circ\text{C}$	680	A ² s
T_j		-55 ... +150	$^\circ\text{C}$
T_{stg}		-55 ... +125	$^\circ\text{C}$
V_{isol}	AC, 1 min.	2500	V

Characteristics		min.	typ.	max.	Units
Symbol	Conditions ¹⁾				
IGBT - Inverter & Chopper					
V_{CEsat}	$I_C = 20 \text{ A}; T_j = 25 (125) \text{ }^\circ\text{C}$	-	2,1(2,2)	2,7(2,8)	V
$t_{d(on)}$	$V_{CC} = 300 \text{ V}; V_{GE} = 15 \text{ V}$	-	40	80	ns
t_r	$I_C = 20 \text{ A}; T_j = 125 \text{ }^\circ\text{C}$	-	70	140	ns
$t_{d(off)}$	$R_{gon} = R_{goff} = 47 \text{ }^\circ\Omega$	-	250	370	ns
t_f	inductive load	-	500	750	ns
$E_{on} + E_{off}$		-	2,5	-	mJ
C_{ies}	$V_{CE} = 25 \text{ V}; V_{GE} = 0 \text{ V}, 1 \text{ MHz}$	-	1,1	-	nF
R_{thjh}	per IGBT	-	-	2,5	K/W
Diode ²⁾ - Inverter & Chopper					
$V_F = V_{EC}$	$I_F = 25 \text{ A}; T_j = 25 (125) \text{ }^\circ\text{C}$	-	1,45(1,4)	1,7(1,7)	V
V_{TO}	$T_j = 125 \text{ }^\circ\text{C}$	-	0,85	0,9	V
r_T	$T_j = 125 \text{ }^\circ\text{C}$	-	22	32	m Ω
I_{RRM}	$I_F = 25 \text{ A}, V_R = -300 \text{ V}$	-	25	-	A
Q_{rr}	$di_F/dt = -500 \text{ A}/\mu\text{s}$	-	2,5	-	μC
E_{off}	$V_{GE} = 0 \text{ V}, T_j = 125 \text{ }^\circ\text{C}$	-	0,75	-	mJ
R_{thjh}	per diode	-	-	2,6	K/W
Diode - Rectifier					
V_F	$I_F = 25 \text{ A}, T_j = 25 \text{ }^\circ\text{C}$	-	1,2	-	V
R_{thjh}	per diode	-	-	2,6	K/W
Temperature Sensor					
R_{Ts}	$T = 25 / 100 \text{ }^\circ\text{C}$		1000 / 1670		Ω
Shunts (SKiiP 21 NEB 06 I)					
$R_{cs(dc)}$	5 %		10		m Ω
$R_{cs(ac)}$	1 %		10		m Ω
Mechanical Data					
M1	case to heatsink, SI Units	2,5	-	3,5	Nm
Case			M2		

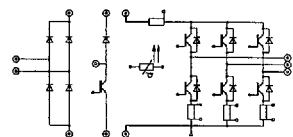
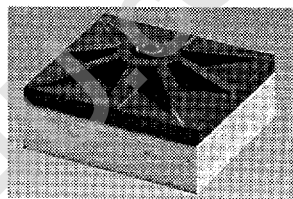
MiniSKiiP 2 SEMIKRON integrated intelligent Power

SKiiP 21 NEB 06
SKiiP 21 NEB 06 I ³⁾

1-phase bridge rectifier +
braking chopper +
3-phase bridge inverter

Preliminary Data

Case M2



Features

- High level power integration
- One-screw-mounting to the customer heatsink, compact design
- Low thermal impedance due to durable ceramic insulation
- Pressure contact technology with simple connection to DCB through pressure contact (no soldering) and with increased power cycling capability
- Low stray inductance
- High power density, low losses
- Integrated temperature sensor
- Integrated shunts for dc and ac current (SKiiP 21 NEB 06 I)
- Mechanical drawing available on disc for Auto CAD 12 (.DWG, .DXF)

¹⁾ $T_{heatsink} = 25 \text{ }^\circ\text{C}$, unless otherwise specified

²⁾ CAL = Controlled Axial Lifetime Technology (soft and fast recovery)

³⁾ With integrated shunts for dc and ac current

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SKIIP 21 NEB 06 ... - SKIIP 21 NAB 06 ... - SKIIP 30 NAB 06 (Chopper)

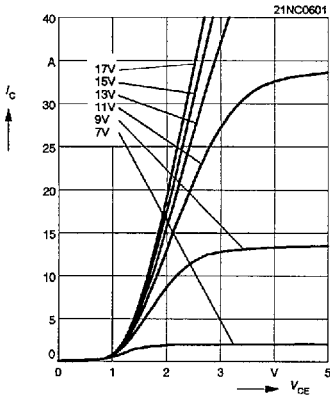


Fig. 1 Typ. output characteristic, $t_p = 80 \mu s$; $25^\circ C$

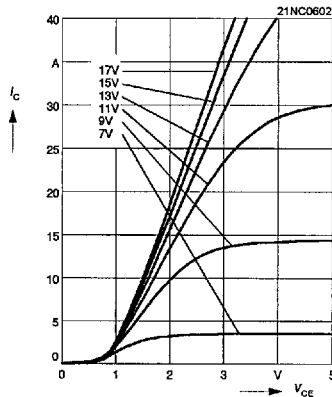


Fig. 2 Typ. output characteristic, $t_p = 80 \mu s$; $125^\circ C$

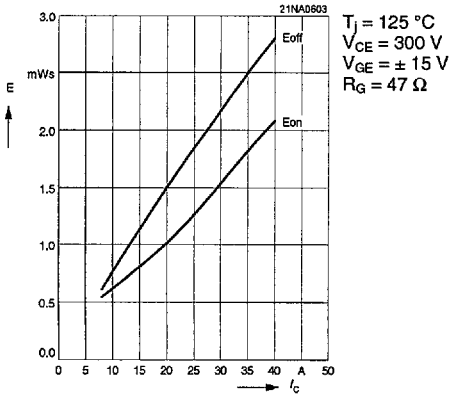


Fig. 3 Turn-on /off energy = $f(I_c)$

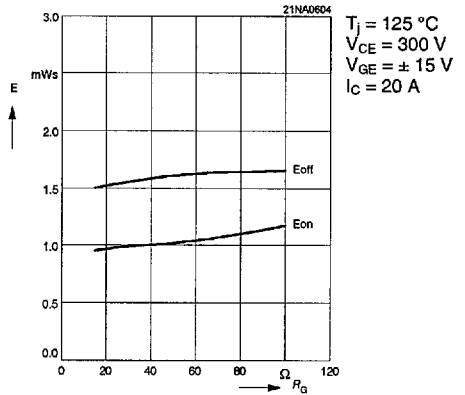


Fig. 4 Turn-on /off energy = $f(R_g)$

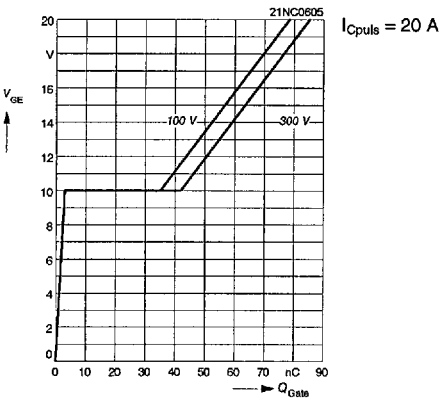


Fig. 5 Typ. gate charge characteristic

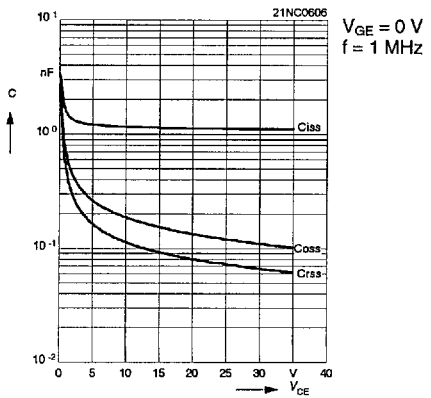


Fig. 6 Typ. capacitances vs. V_{CE}